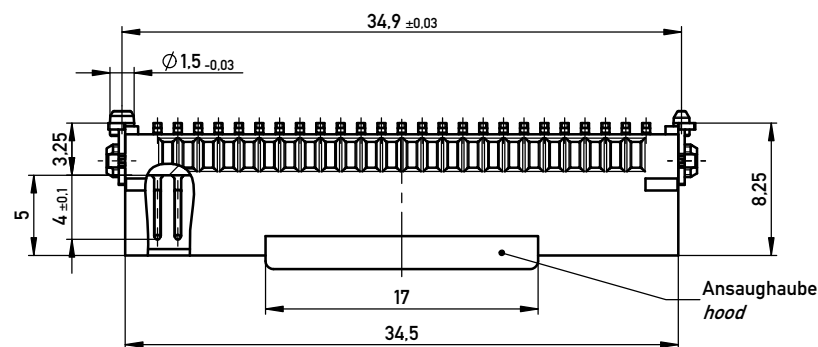
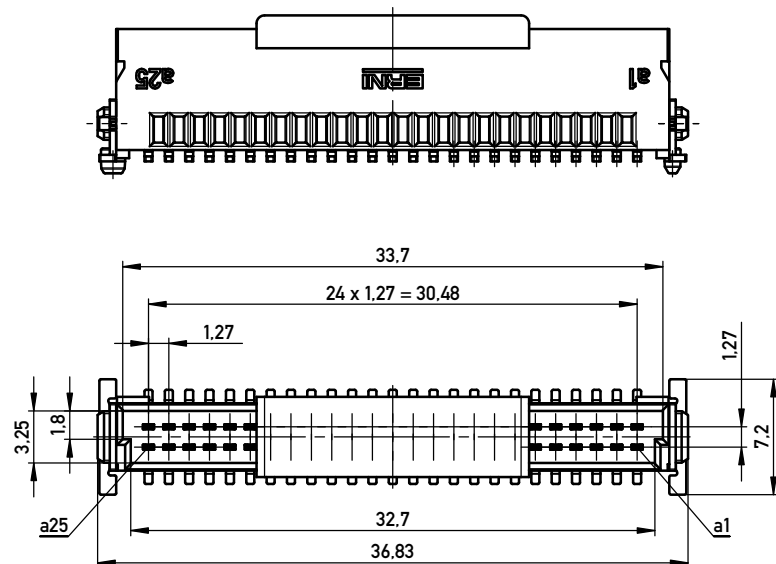
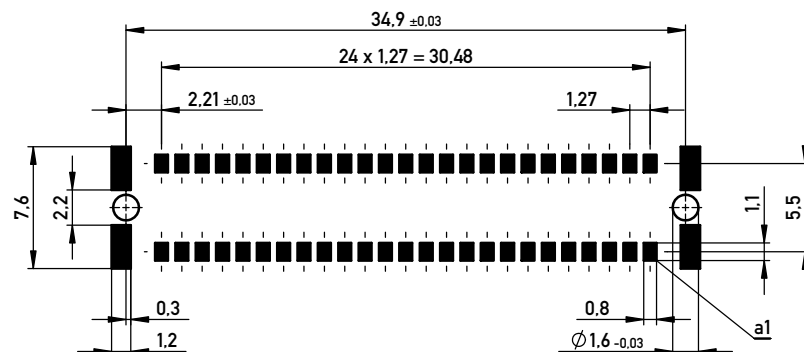


Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



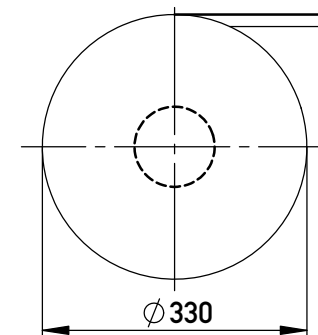
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

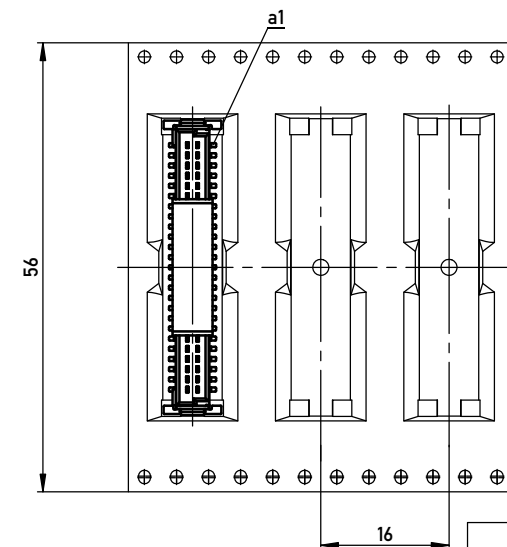
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0.1 mm

Verpackt in Gurtverpackung
Tape on Reel Packaging
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



BA 8-03 - Standard Bauhöhe

type 8-03 - Standard Assembly Height

Information:		Tolerances		Scale	3:1
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		www.ERNI.com		244856	
d	08.07.2013			I	
Index	Date			A3	
		Class		SMCQ	

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